# 2SB1172, 2SB1172A

### Silicon PNP epitaxial planar type

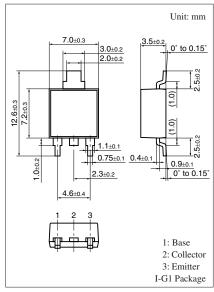
For low-frequency power amplification Complementary to 2SD1742, 2SD742A

#### ■ Features

- $\bullet$  High forward current transfer ratio  $h_{F\!E}$  which has satisfactory linearity
- ullet Low collector-emitter saturation voltage  $V_{\text{CE(sat)}}$
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment

#### ■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SB1172	V <sub>CBO</sub>	-60	V
(Emitter open)	2SB1172A		-80	
Collector-emitter voltage	2SB1172	V <sub>CEO</sub>	-60	V
(Base open)	2SB1172A		-80	
Emitter-base voltage (Col	V <sub>EBO</sub>	-5	V	
Collector current	$I_C$	-3	A	
Peak collector current	$I_{CP}$	-5	A	
Collector power dissipation	$P_{C}$	15	W	
	$T_a = 25^{\circ}C$		1.3	
Junction temperature	$T_{j}$	150	°C	
Storage temperature	$T_{stg}$	-55 to +150	°C	



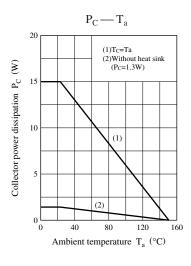
Note) Self-supported type package is also prepared.

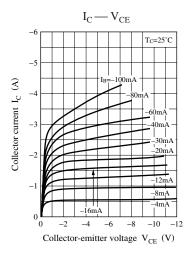
### ■ Electrical Characteristics $T_C = 25$ °C $\pm 3$ °C

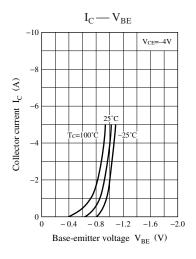
Parameter		Symbol Conditions		Min	Тур	Max	Unit
Collector-emitter voltage	2SB1172	V <sub>CEO</sub>	$I_C = -30 \text{ mA}, I_B = 0$	-60			V
(Base open)	2SB1172A			-80			
Base-emitter voltage		$V_{BE}$	$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$			-1.8	V
Collector-emitter cutoff	2SB1172	I <sub>CES</sub>	$V_{CE} = -60 \text{ V}, V_{BE} = 0$			-200	μΑ
current (E-B short)	2SB1172A		$V_{CE} = -80 \text{ V}, V_{BE} = 0$			-200	
Collector-emitter cutoff	2SB1172	$I_{CEO}$	$V_{CE} = -30 \text{ V}, I_B = 0$			-300	μΑ
current (Emitter open)	2SB1172A		$V_{CE} = -60 \text{ V}, I_B = 0$			-300	
Emitter-base cutoff current (Collector open)		$I_{EBO}$	$V_{EB} = -5 \text{ V}, I_C = 0$			-1	mA
Forward current transfer ratio		h <sub>FE1</sub> *	$V_{CE} = -4 \text{ V}, I_{C} = -1 \text{ A}$	70		250	_
		h <sub>FE2</sub>	$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$	10			
Collector-emitter saturation	voltage	V <sub>CE(sat)</sub>	$I_C = -3 \text{ A}, I_B = -0.375 \text{ A}$			-1.2	V
Transition frequency		$f_T$	$V_{CE} = -10 \text{ V}, I_{C} = -0.5 \text{ A}, f = 10 \text{ MHz}$		30		MHz
Turn-on time		t <sub>on</sub>	$I_C = -1 A, I_{B1} = -0.1 A, I_{B2} = 0.1 A$		0.5		μs
Storage time		t <sub>stg</sub>	$V_{CC} = -50 \text{ V}$		1.2		μs
Fall time		t <sub>f</sub>			0.3		μs

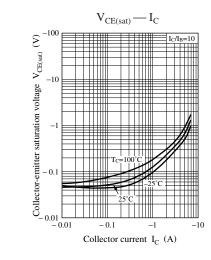
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

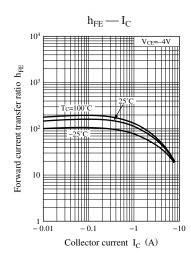
2. *: Rank classification	Rank	Q	Р	
	$h_{EE2}$	70 to 150	120 to 250	

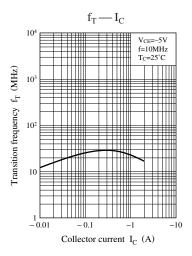


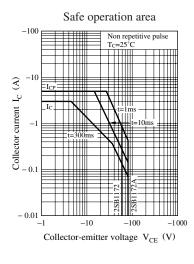


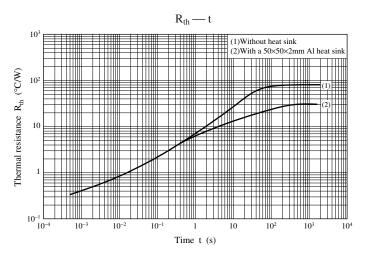












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